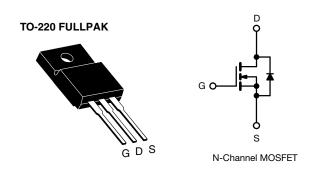
Vishay Siliconix

# **D Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	450			
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.6			
Q <sub>g</sub> max. (nC)	30			
Q <sub>gs</sub> (nC)	4			
Q <sub>gd</sub> (nC)	7			
Configuration	Single			

### **FEATURES**

- Optimal design
  - Low area specific on-resistance
  - Low input capacitance (Ciss)
  - Reduced capacitive switching losses
  - High body diode ruggedness
  - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
  - Low cost
  - Simple gate drive circuitry
  - Low figure-of-merit (FOM): Ron x Qa
  - Fast switching
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **APPLICATIONS**

- Consumer electronics
  - Displays (LCD or plasma TV)
- Server and telecom power supplies
  - SMPS
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- · Battery chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF10N40D-E3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			$V_{DS}$	400	
Gate-Source Voltage				± 30	V
Gate-Source Voltage AC (f > 1 Hz)			$V_{GS}$	30	
Continuous Drain Current (T <sub>.I</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	10	
Continuous Drain Current (1) = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		6	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	23	
Linear Derating Factor				0.26	W/°C
Single Pulse Avalanche Energy b			E <sub>AS</sub>	194	mJ
Maximum Power Dissipation			$P_{D}$	33	W
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-Source Voltage Slope T <sub>J</sub> = 125 °C		dV/dt	24	V/ns	
Reverse Diode dV/dt <sup>d</sup>			0.6	V/11S	
Soldering Recommendations (Peak temperature) <sup>c</sup>	ommendations (Peak temperature) <sup>c</sup> For 10 s			300	°C
Mounting Torque M3 screw		crew		0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 2.3 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 13 A.
- c. 1.6 mm from case.
- d.  $I_{SD} \leq I_{D}$ , starting  $T_{J}$  = 25 °C.
- e. Limited by maximum junction temperature.



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.8	G/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•		•		•	
Drain-Source Breakdown Voltage	$V_{DS}$	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3	-	5	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	lana	V <sub>DS</sub> =	= 400 V, V <sub>GS</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Gunerit	I <sub>DSS</sub>	$V_{DS} = 320 \text{ V}$	$V_{\rm S} = 0 \ V_{\rm T} = 125 \ ^{\circ}{\rm C}$	-	-	10	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	$I_D = 5 A$	-	0.5	0.6	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 5 A		-	2.7	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	526	-	
Output Capacitance	$C_{oss}$		$V_{DS} = 100 \text{ V},$	-	59	-	
Reverse Transfer Capacitance	$C_{rss}$		f = 1 MHz	-	9	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>		V <sub>GS</sub> = 0 V,	-	66	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>D</sub>	$V_{DS} = 0 \text{ V to } 320 \text{ V}$		84	-	
Total Gate Charge	Qq			-	15	30	
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> = 10 V	$I_D = 5 A, V_{DS} = 320 V$	-	4	-	nC
Gate-Drain Charge	$Q_{gd}$			-	7	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	12	24	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 400 V, I <sub>D</sub> = 10 A,	-	18	36	
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, $R_g = 9.1 \Omega$	-	18	36	ns
Fall Time	t <sub>f</sub>	7	•	-	14	28	
Gate Input Resistance	Rg	f = 1	MHz, open drain	0.9	1.8	3.6	Ω
<b>Drain-Source Body Diode Characteristic</b>	S						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	bol	-	-	10	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	40	- A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			-	230	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 5 \text{A},$		-	μC		
Reverse Recovery Current	I <sub>RRM</sub>	dl/dt = 100 A/ $\mu$ s, $V_R$ = 25 V		-	14	-	A

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

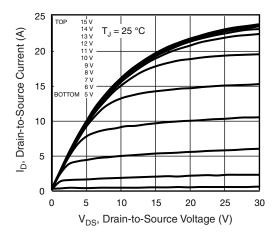


Fig. 1 - Typical Output Characteristics

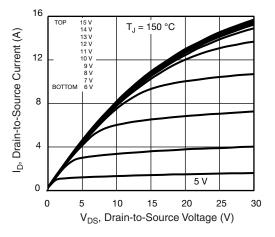


Fig. 2 - Typical Output Characteristics

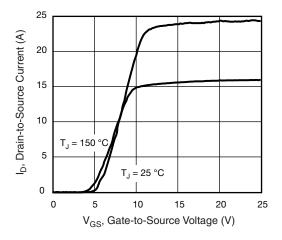


Fig. 3 - Typical Transfer Characteristics

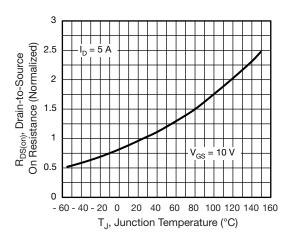


Fig. 4 - Normalized On-Resistance vs. Temperature

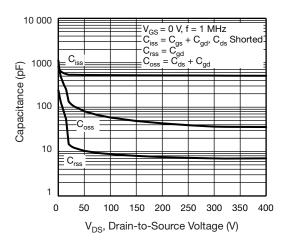


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

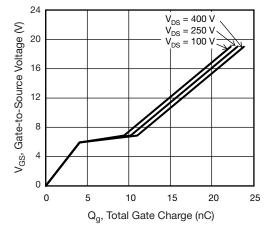


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



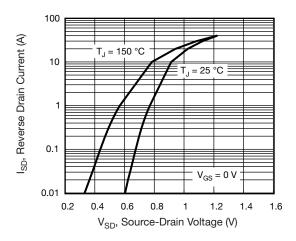


Fig. 7 - Typical Source-Drain Diode Forward Voltage

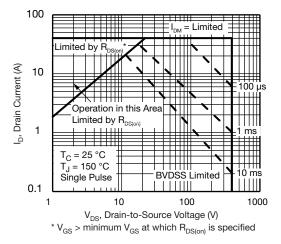


Fig. 8 - Maximum Safe Operating Area

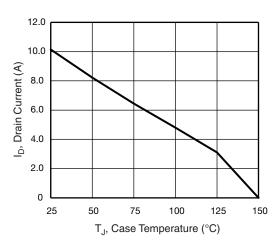


Fig. 9 - Maximum Drain Current vs. Case Temperature

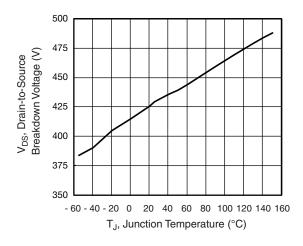


Fig. 10 - Temperature vs. Drain-to-Source Voltage

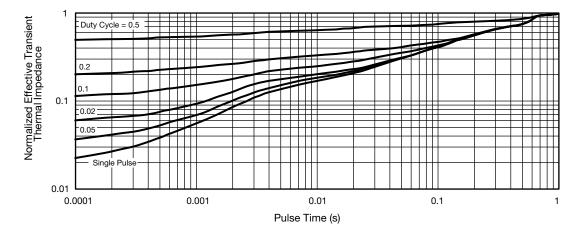


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

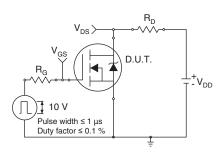


Fig. 12 - Switching Time Test Circuit

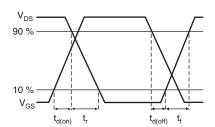


Fig. 13 - Switching Time Waveforms

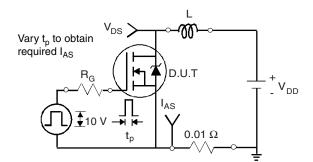


Fig. 14 - Unclamped Inductive Test Circuit

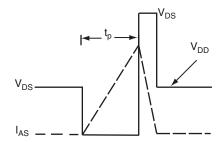


Fig. 15 - Unclamped Inductive Waveforms

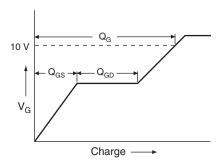


Fig. 16 - Basic Gate Charge Waveform

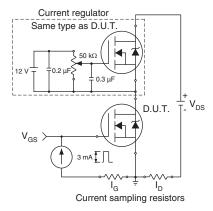
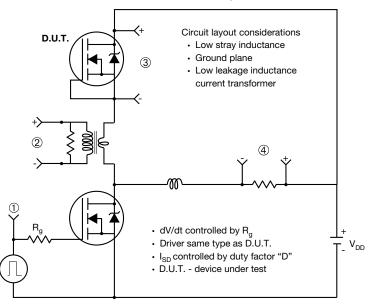


Fig. 17 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



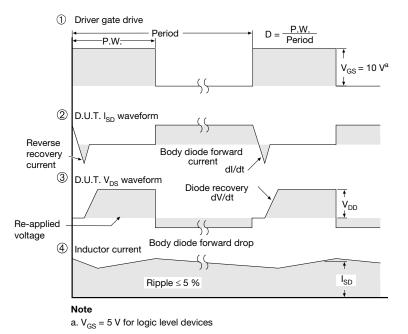


Fig. 18 - For N-Channel

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Vishay Siliconix

# **TO-220 FULLPAK (High Voltage)**

## **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



## **OPTION 2: FACILITY CODE = Y**



	MILLIM	ETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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